

PIC252012 TYPE

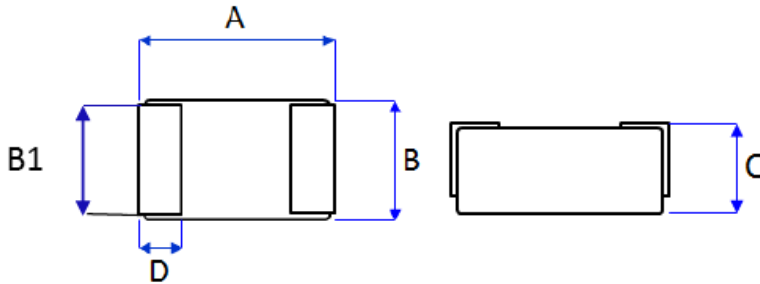
●FEATURE

1. Shielded construction(height=1.20mm Max)
2. Frequency range up to 5MHz, Low DCR(Ω)

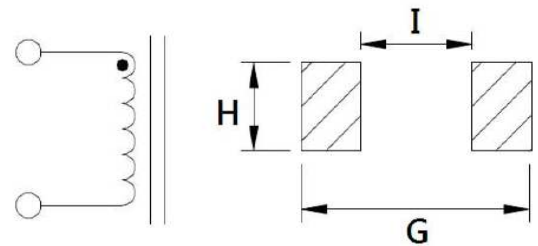
●Applications

1. Notebook, server application, High current power supplier

●Shape and Dimension



●Schematics and Land Patterns(mm)



A=2.5±0.2m/m ; B=2.0±0.2m/m ; B1=1.84±0.2m/m; C=1.20m/m Max. ; D=0.60±0.3m/m
 G=2.90m/m Ref. ; H=2.1m/m Ref. ; I=1.2m/m Ref.

●Specification

P/N	L (μ H)	RDC (m Ω)Max	Isat (A)	Irms (A)	SRF (MHz) min	Q min
PIC252012-R33M	0.33±20%	17.0	4.3	5.6	30	30
PIC252012-R47M	0.47±20%	25.0	3.8	4.5	30	30
PIC252012-R68M	0.68±20%	43.0	3.0	4.0	30	30
PIC252012-1R0M	1.0±20%	53.0	2.8	3.1	30	30
PIC252012-2R2M	2.2±20%	98.0	1.8	2.3	10	30

Note1. Measurement frequency of Inductance value : at 1MHz, 1V

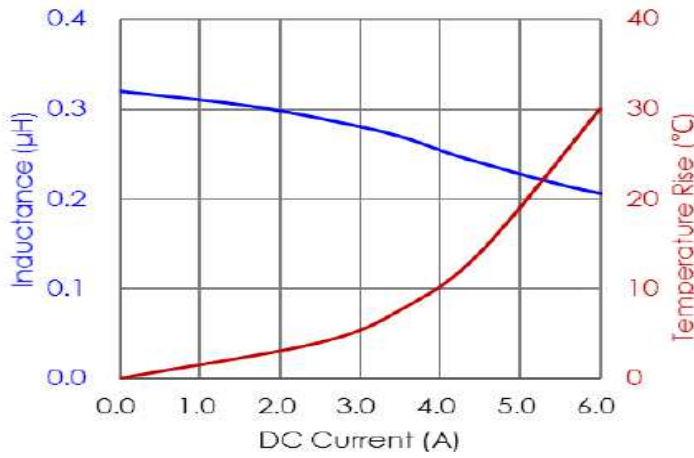
Note2. Measurement ambient temperature of L, DCR and IDC : at 25°C

Note3. Isat: DC current at which the inductance drops 30%(typ) from its value without current

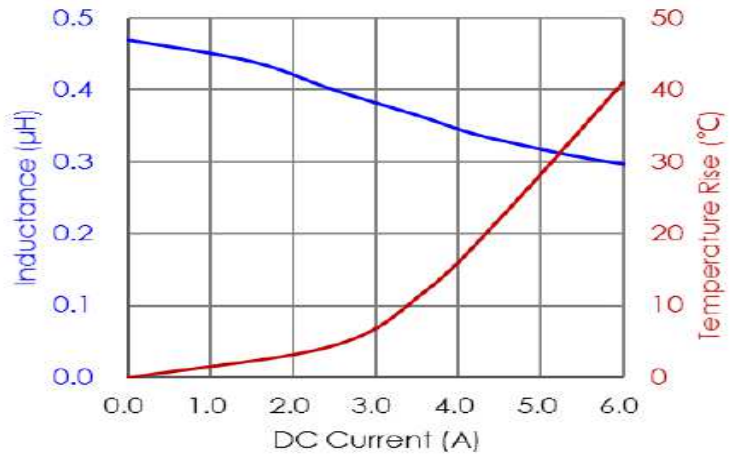
Note4. Irms: Average current for 40°C temperature rise from 25°C ambient(typical)

● Typical Electrical Curve: Inductance VS Isat , Irms VS TEMP.

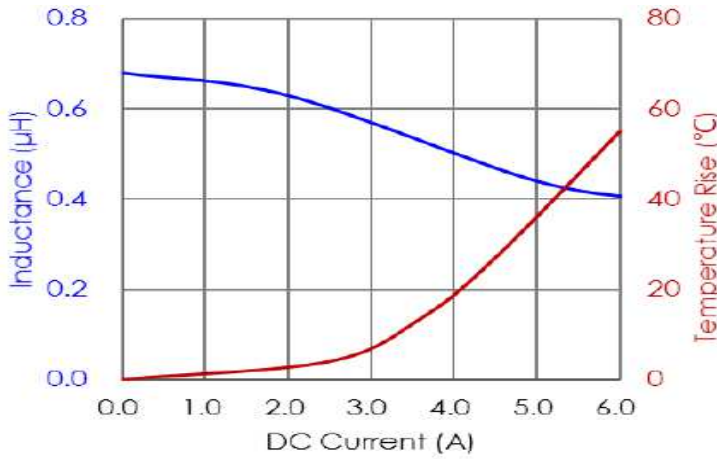
PIC252012-R33



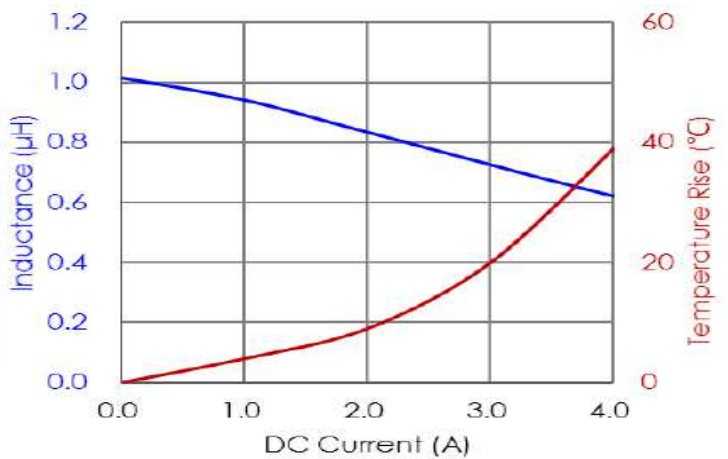
PIC252012-R47



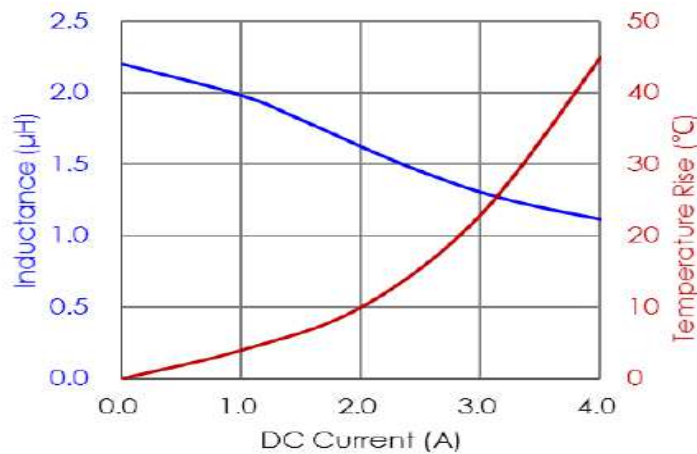
PIC252012-R68



PIC252012-1R0

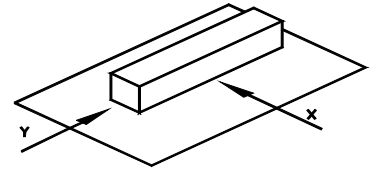


PIC252012-2R2

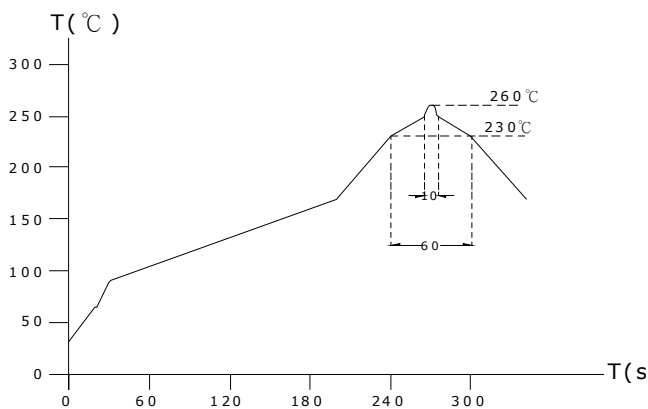


GENERAL CHARACTERISTICS

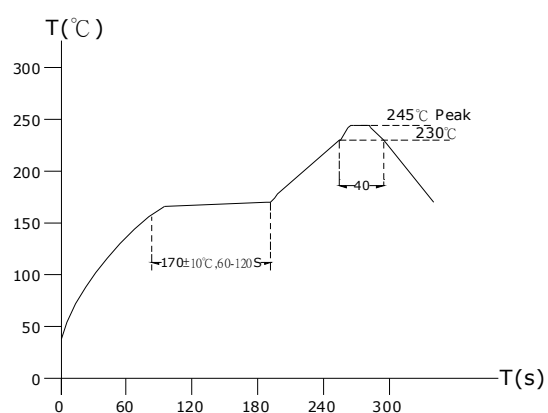
1. Operating temperature range: -55 TO + 125°C (Includes temperature when the coil is heated)
2. External appearance: On visual inspection, the coil has no external defects.
3. Terminal strength: After soldering. Between copper plate and terminals of coil. Push in two directions of X.Y withstanding at below conditions.
Terminal should not peel off. (refer to figure at right) 5. 0N 60 sec.
4. Insulating resistance: Over 100MΩ at 100V D.C. between coil and core.
5. Dielectric strength: No dielectric breakdown at 100V D.C. for 1 minute between coil and core.
6. Temperature characteristics: Inductance coefficient $(0\sim 2,000)\times 10^{-6}/^{\circ}\text{C}$ (-25~+80°C degree Celsius), inductance deviation within $\pm 5.0\%$, after 96 hours.
7. Humidity characteristics(Moisture Resistance): Inductance deviation within $\pm 5\%$, after 96 hours in 90~95% relative humidity at $40 \pm 2^{\circ}\text{C}$ and 1 hour drying under normal condition.
8. Vibration resistance: Inductance deviation within $\pm 5\%$, after vibration for 1 hour. In each of three orientations at sweep vibration (10~55~10 Hz) with 1.5mm P-P amplitudes.
9. Shock resistance: Inductance deviation within $\pm 5\%$, after being dropped once with 981m/s² (100G) shock attitude upon a rubber block method shock testing machine, in three different orientations.
10. Resistance to Soldering Heat: 260°C, 10 seconds(See attached recommend reflow)
11. Storage condition: Temperature Range: 0°C ~ 35°C ; -40°C ~ 125°C (after PCB) , Humidity Range: 50% ~ 70% RH
12. Use components within 12 months. If 12 months or more have elapsed, check solderability before use.
13. Reflow profile recommend:



Lead-free heat endurance test

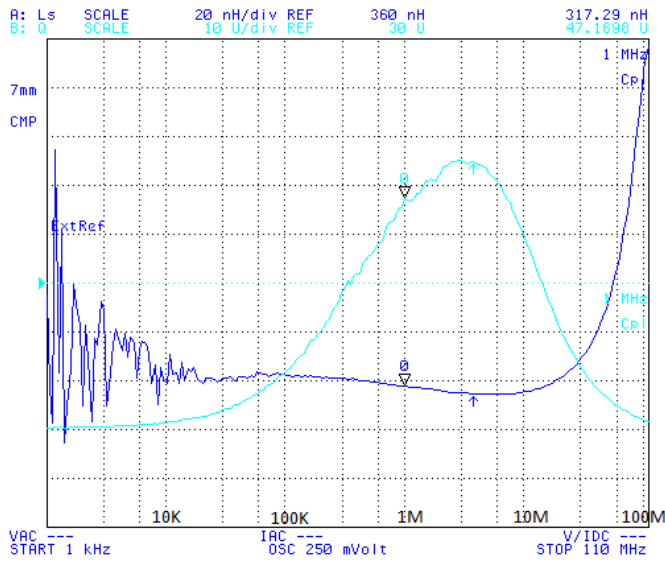


Lead-free the recommended reflow condition

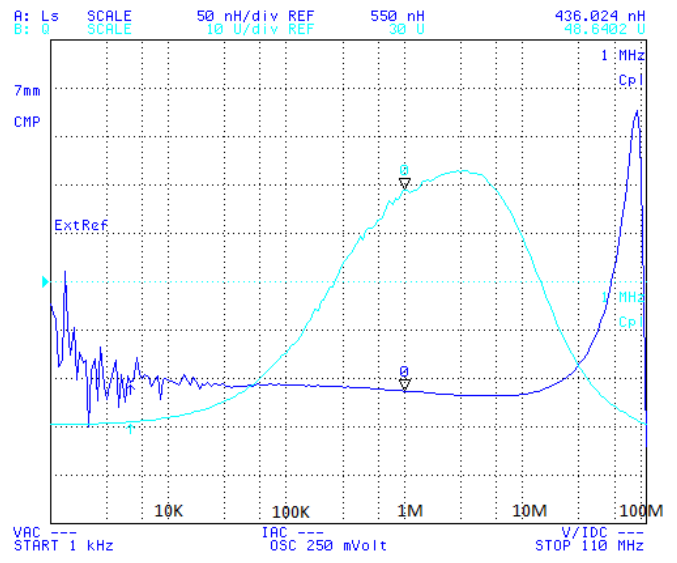


● Typical Electrical Curve: SRF

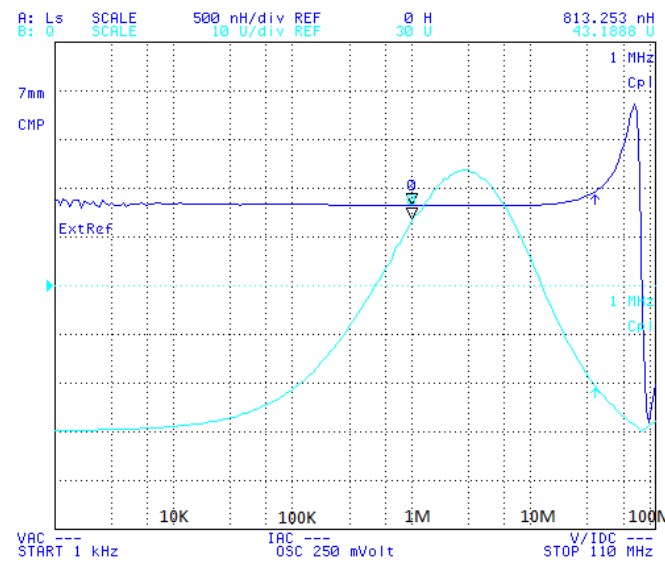
PIC252012-R33



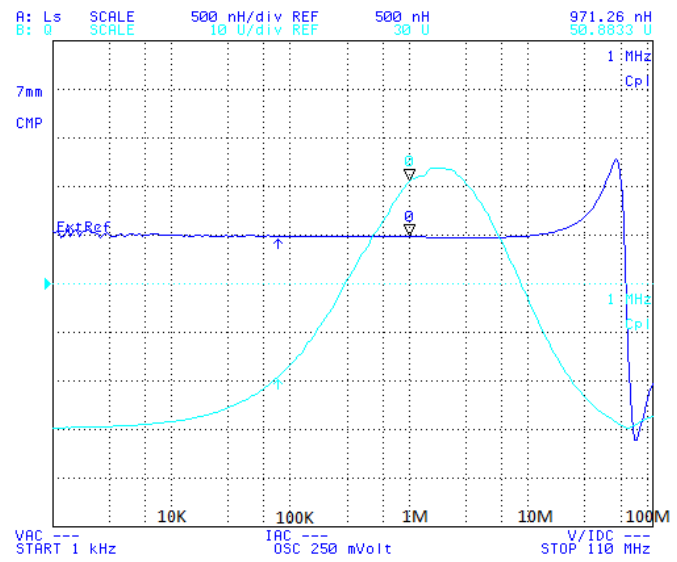
PIC252012-R47



PIC252012-R68



PIC252012-1R0



PIC252012-2R2

